

OptiMOS™-5 Power-Transistor





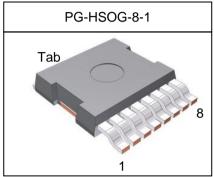
Features

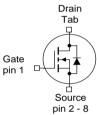
- N-channel Enhancement mode
- AEC qualified
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- Ultra low Rds(on)
- 100% Avalanche tested

Туре	Package	Marking
IAUS240N08S5N019	PG-HSOG-8-1	A08S5N19

Product Summary

V_{DS}	80	V
R _{DS(on)}	1.9	mΩ
I _D	240	Α





Maximum ratings, at T_j =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	$T_{\rm C}$ =25°C, $V_{\rm GS}$ =10V ¹⁾	240	А
		T _C =100 °C, V _{GS} =10 V ²⁾	173	
Pulsed drain current ²⁾	I _{D,pulse}	T _C =25 °C	960	
Avalanche energy, single pulse ²⁾	E _{AS}	I _D =120 A	400	mJ
Avalanche current, single pulse	I _{AS}	-	240	А
Gate source voltage	V_{GS}	-	±20	V
Power dissipation	P_{tot}	T _C =25 °C	230	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	



Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics ²⁾						
Thermal resistance, junction - case	R_{thJC}	-	-	-	0.65	K/W

Electrical characteristics, at T_j =25 °C, unless otherwise specified

Static characteristics

Drain-source breakdown voltage ²⁾	V _{(BR)DSS}	V _{GS} =0 V, I _D =1 mA	80	-	-	V
Gate threshold voltage	$V_{\rm GS(th)}$	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 160 \ \mu {\rm A}$	2.2	3	3.8	
Zero gate voltage drain current ²⁾	I _{DSS}	$V_{\rm DS} = 80 \text{ V}, V_{\rm GS} = 0 \text{ V}, $ $T_{\rm j} = 25 \text{ °C}$	1	0.1	1	μA
		$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =85 °C ²⁾	-	1	20	
Gate-source leakage current	I _{GSS}	V _{GS} =20 V, V _{DS} =0 V	-	1	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =6 V, I _D =60 A	-	2.0	3.0	mΩ
		V _{GS} =10 V, I _D =100 A	-	1.5	1.9	



Parameter	Symbol	bol Conditions		Values		
			min.	typ.	max.	
Dynamic characteristics ²⁾						
Input capacitance	Ciss		-	7126	9264	pF
Output capacitance	Coss	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz	-	1152	1498	1
Reverse transfer capacitance	C _{rss}		-	51	76	
Turn-on delay time	$t_{\rm d(on)}$		-	18	-	ns
Rise time	t _r	V _{DD} =40 V, V _{GS} =10 V,	-	12	-	1
Turn-off delay time	$t_{\text{d(off)}}$	$I_{\rm D}$ =100 A, $R_{\rm G}$ =3.5 Ω	-	35	-	1
Fall time	t_{f}	1	-	36	-	1
Gate Charge Characteristics ²⁾	T ₀	<u> </u>		32	42	nC
Gate to source charge Gate to drain charge	$Q_{\rm gs}$ $Q_{\rm gd}$	V_{DD} =40 V, I_{D} =100 A, V_{GS} =0 to 10 V		22	33	
Gate to drain charge Gate charge total	Q _{gd}			100	130	
Gate plateau voltage	V _{plateau}		-	4.7	-	V
Reverse Diode	•					
Diode continous forward current ²⁾	Is	T 05 00	-	-	240	А
Diode pulse current ²⁾	I _{S,pulse}	T _C =25 °C	-	-	960	Ī
Diode forward voltage	V_{SD}	V _{GS} =0 V, I _F =100 A, T _j =25 °C	-	0.9	1.2	V
Reverse recovery time ²⁾	t _{rr}	V_{R} =40 V, I_{F} =50A, di_{F}/dt =100 A/ μ s	-	71	-	ns
Reverse recovery charge ²⁾	Q _{rr}		-	126	-	nC

 $^{^{1)}}$ Current is limited by bondwire; with an $R_{\rm thJC}$ = 0.65 K/W the chip is able to carry 246A at 25°C.

²⁾ Defined by design. Not subject to production test.



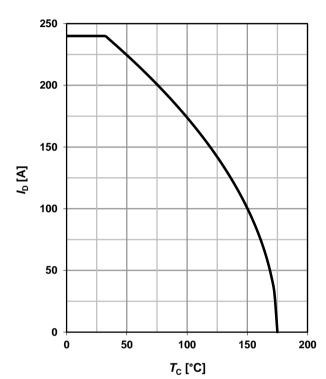
1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} \ge 6 \text{ V}$$

250 200 150 100 50 100 50 100 150 200 T_C [°C]

2 Drain current

$$I_D = f(T_C); V_{GS} \ge 6 \text{ V}$$



3 Safe operating area

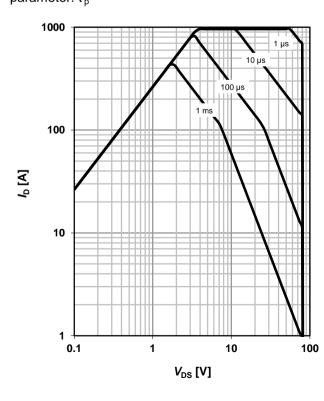
$$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0$$

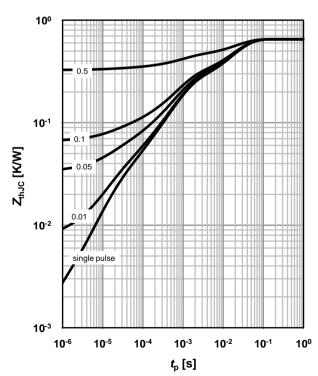
parameter: t_p

4 Max. transient thermal impedance

$$Z_{\text{thJC}} = f(t_{p})$$

parameter: $D=t_p/T$



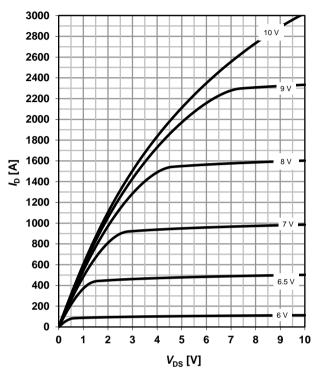




5 Typ. output characteristics

 $I_{\rm D} = f(V_{\rm DS}); T_{\rm i} = 25 \,{}^{\circ}{\rm C}$

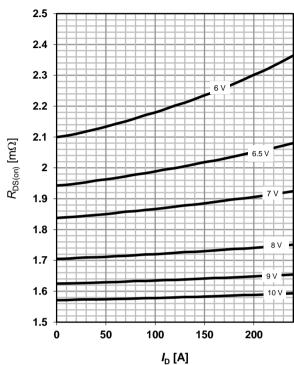
parameter: V_{GS}



6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 \text{ °C}$

parameter: $V_{\rm GS}$



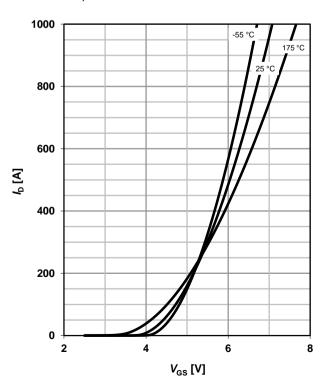
7 Typ. transfer characteristics

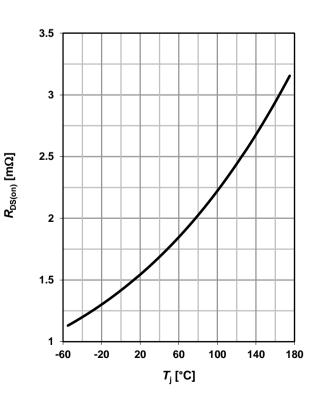
 $I_D = f(V_{GS}); V_{DS} = 6V$

parameter: $T_{\rm j}$

8 Typ. drain-source on-state resistance

$$R_{DS(on)} = f(T_j); I_D = 100 \text{ A}; V_{GS} = 10 \text{ V}$$







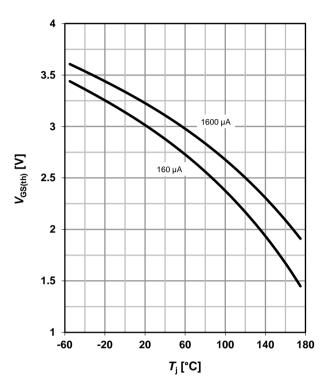
9 Typ. gate threshold voltage

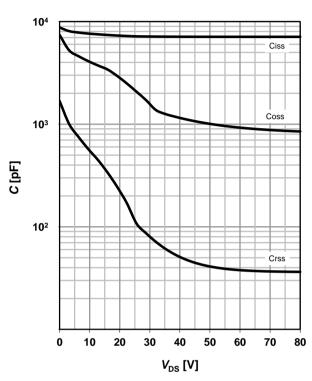
 $V_{GS(th)} = f(T_i); V_{GS} = V_{DS}$

parameter: I_D

10 Typ. capacitances

 $C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$





11 Typical forward diode characteristics

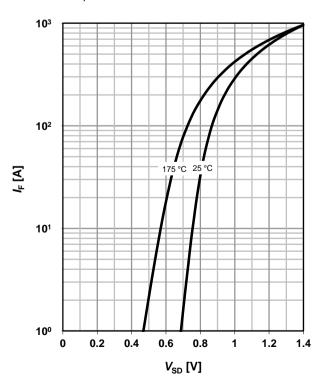
 $IF = f(V_{SD})$

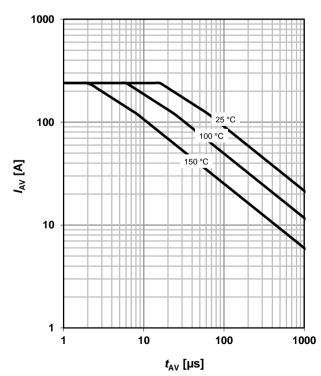
parameter: $T_{\rm j}$

12 Typ. avalanche characteristics

 $I_{AS} = f(t_{AV})$

parameter: T_{j(start)}







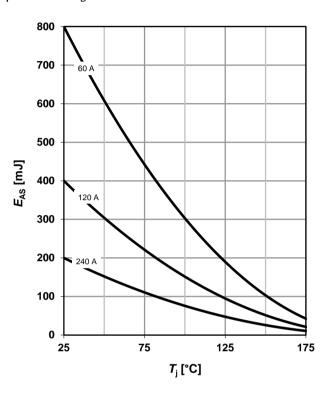
13 Typical avalanche energy

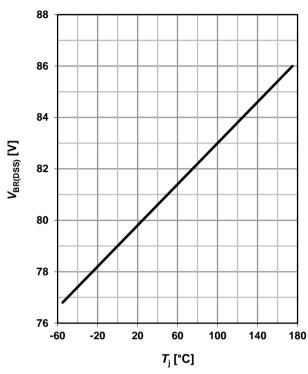
 $E_{AS} = f(T_i)$

parameter: I_D

14 Drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_{D_{typ}} = 1 \text{ mA}$$



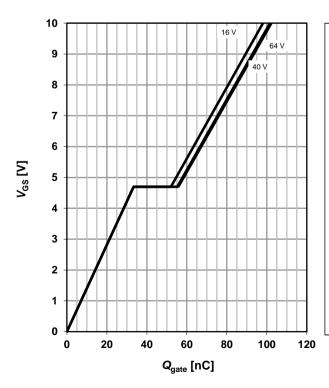


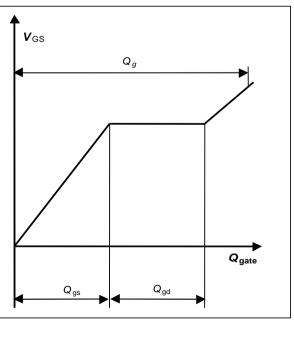
15 Typ. gate charge

 $V_{GS} = f(Q_{gate}); I_D = 100 A pulsed$

parameter: V_{DD}









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Revision History

Version	Date	Changes
Version 1.0	25.05.2018	Final Data Sheet

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